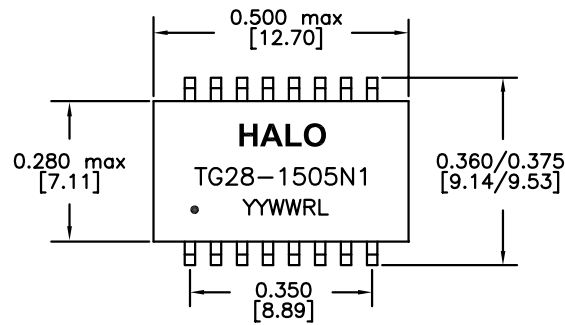
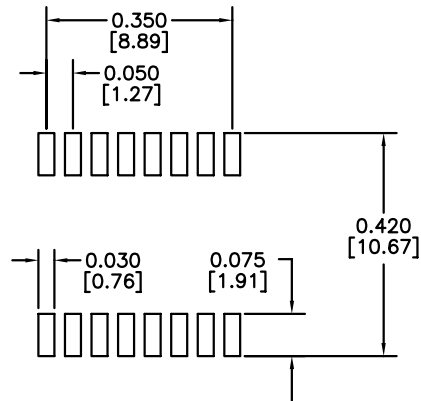


DIMENSIONS: Inch [mm]
CO-PLANARITY: 0.004 [0.10]
TOLERANCES: ±0.005 INCH IF NOT SPECIFIED



RECOMMENDED SOLDER PAD DIMENSIONS

PART NO. : TG28-1505N1RL

16PIN DUAL SMT T1/E1 ISOLATION MODULE

RoHS COMPLIANT

COMPATIBLE TO LEAD-FREE SOLDERING PROCESS
CONDITION PER IPC/JEDEC J-STD-020C

UL/EN60950 AND DEMKO REGONIZED

EXTENDED OPERATING TEMPERATURE -40/+85°C

ELECTRICAL SPECIFICATIONS @25° C

URNS RATIO

P16-14:P1-3

P6-8:P11-9

1CT:1CT±2%

1CT:1.36CT±2%

OCL PRI

1.5mH typ

DCR PRI

0.8Ω max

Cw/w

35pF max

LL PRI

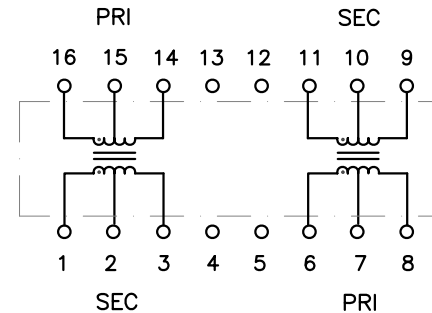
0.5μH max

CROSSTALK 0.5-5MHz

-60dB typ

ISOLATION

1,500Vrms



HALO/PBL

CALIFORNIA, USA
KOWLOON, HONG KONG
SINGAPORE

TITLE SMT ISOLATION MODULE

FOR T1/E1 (1:1,1:1.36)

PART NO. TG28-1505N1RL

SCALE NONE

PAGE 1 OF 1

SIGNATURES

DRAWN LI ZHI ZHONG

CHECKED LEI KEONG

APPROVED PETER LU

FILE 1505N1RL.DWG

DATE

10/18/06

10/26/10

10/26/10

REV.

A

B

DESC.

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DATE

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